

ROHS

MPLIA

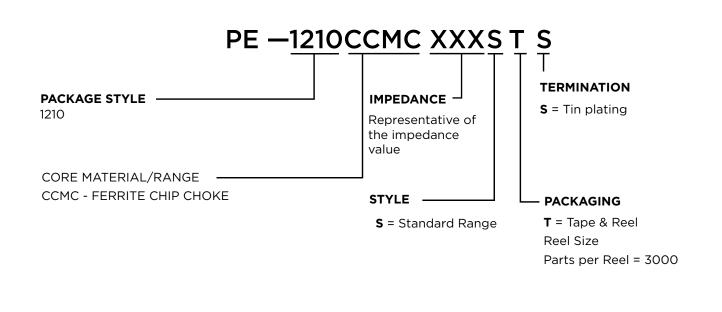
SMD CHIP CHOKES

Wire-Wound Series



- Common Mode Noise suppression without attenuating the signal
- Magnetically shielded for low Rdc and High Current
- Perfect for USB2.0/3.0, IEEE1349 Fire wire and other LVDS lines
- Ideal for DC voltage supply lines for Power over Ethernet -PoE/PoE+

PART NUMBER LEGEND



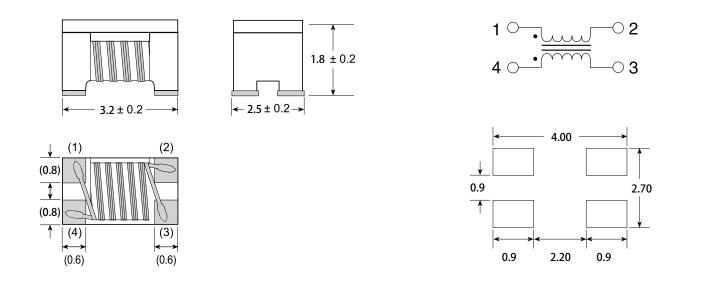


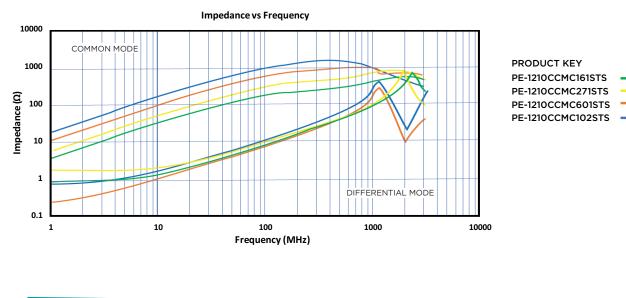
WIRE-WOUND CHIP CHOKES

SPECIFICATION

Electrical Specifications @ 25°C										
Part Number (25%)	Common Mode Impedance @ 100MHz (Ω)	DC Resistance (Ω MAX)	Rated Voltage (Vdc)	Rated Current (mA MAX)	Withstanding Voltage (Vdc)	Insulation Resistance $(M\Omega MIN)$				
PE-1210CCMC161STS	160	0.15	50	680	125	10				
PE-1210CCMC271STS	270	0.25	50	640	125	10				
PE-1210CCMC601STS	600	0.12	50	1000	125	10				
PE-1210CCMC102STS	1000	0.35	50	480	125	10				

Mechanical







2

WIRE-WOUND CHIP CHOKES

PERFORMANCE TESTING

	Electrical Testing			
Storage and Operating Temperature Range: -40° to +85°C Thermal: -40° to +85°C Moisture Resistance	Inductors are subjected to the extremes for 48 hours. Then tested at 25°C Inductors are subjected to 30 cycles for 30 minutes at each extreme. Then tested at 25°C Inductors are subjected to 30 cycles for 30 minutes at each extreme. Then tested at 25°C Inductors are subjected to 10 cycles of 24 hours at 70°C with 90 to 95% Relative Humidity Then tested at 25°C	There shall be no deformation or change in appearance Inductance shall not change by more than ±5% Q values shall not change by more than ±10%		
Operating Life	Inductors are subjected to 1000 hours at 85°C with 85% Relative Humidity with the rated current applied	There shall be no Damaged, Open or Shorted Windings		
	Mechanical Testing			
Temperature Range:	Inductors are subjected to the following: Use a solder pot at 260C, with RMA Flux. Each termination is immersed in 63Sn/37Pb molten solder for 4 to 6 seconds.	There shall be no deformation or change in appearance Inductance shall not change by more than ±5% Q values shall not change by more than ±10%		
Recommended Solder Heat Resistance Profile	300 T 275 E 250 Image: Constraint of the second seco			



25 0 0

25

50

75

100

TIME (SECOND)

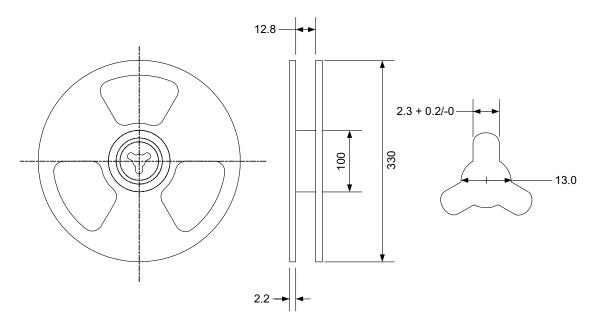
C°

W719.A (7/18) Pulse

300

125 150 175 200 225 250 275

TAPE AND REEL SPECIFICATIONS



Series	Parts per Reel	Tape Dimensions (mm)						
		W	P1	P2	P3	H	T	
1210CCMC	3000	12	2	8	4	2.3	0.3	
Р	1→ ←	→ P2	. ← →	P3 ←		→ H		
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For More Information:

Americas - prodinfonetworkamericas@pulseelectronics.com | Europe - comms-Apps-Europe@pulseelectronics.com | Asia - prodinfonetworkapac@pulseelectronics.com

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